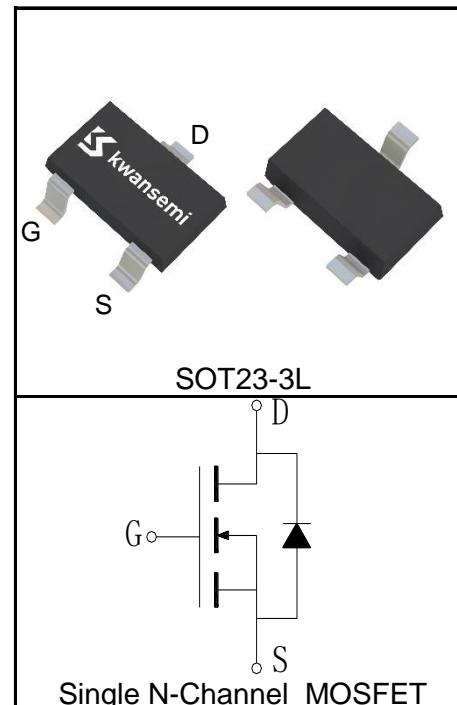


## Features

- 100V/3A,
- $R_{DS(ON)} = 90m\Omega$ (Typ.)@ $V_{GS}=10V$
- $R_{DS(ON)} = 100m\Omega$ (Typ.)@ $V_{GS}=4.5V$
- Low  $R_{DS(ON)}$
- Super High Dense Cell Design
- Low Capacitance to Minimize Driver Losses
- Fast Switching Speed

## Pin Description



## Applications

- Load Switch



Halogen-Free

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
<b>Common Ratings</b> ( $T_A=25^\circ C$ Unless Otherwise Noted)			
$V_{DSS}$	Drain-Source Voltage	100	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_{Jmax}$	Maximum Junction Temperature	150	$^\circ C$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to 150	$^\circ C$
$I_S$	Diode Continuous Forward Current	$T_A=25^\circ C$	A
<b>Mounted on Large Heat Sink</b>			
$I_{DP}^{①}$	300 $\mu s$ Pulse Drain Current Tested	$T_A=25^\circ C$	12
$I_D^{②}$	Continuous Drain Current( $V_{GS}=10V$ )	$T_A=25^\circ C$	3
		$T_A=70^\circ C$	2.4
$P_D$	Maximum Power Dissipation	$T_A=25^\circ C$	1.3
		$T_A=70^\circ C$	0.8
$R_{\theta JL}$	Thermal Resistance-Junction to Lead	60	$^\circ C/W$
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient	100	$^\circ C/W$
<b>Drain-Source Avalanche Ratings</b>			
$E_{AS}^{④}$	Avalanche Energy, Single Pulsed	25	mJ

**Electrical Characteristics** ( $T_A=25^\circ\text{C}$  Unless Otherwise Noted)

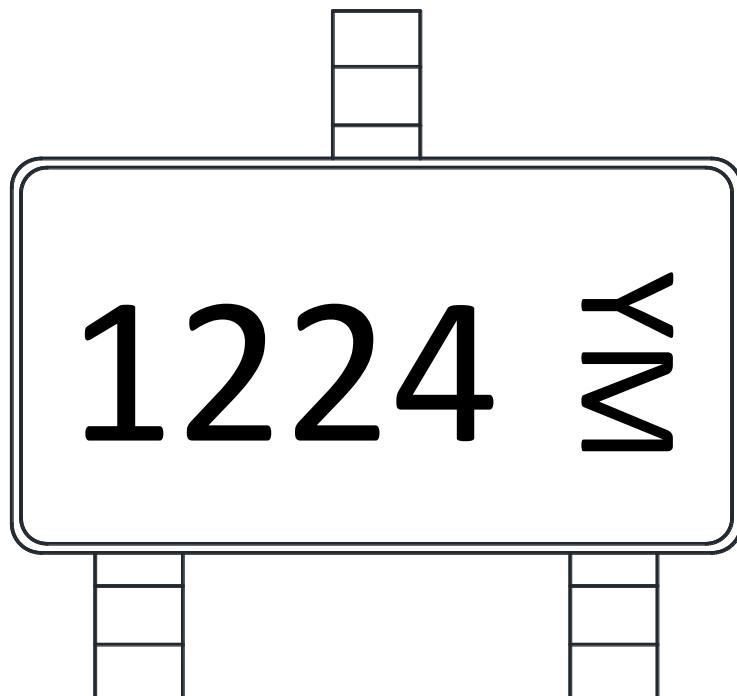
Symbol	Parameter	Test Condition	KS1224EA			Unit
			Min.	Typ.	Max.	
<b>Static Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{DS}}=250\mu\text{A}$	100			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}$		1		$\mu\text{A}$
		$T_J=125^\circ\text{C}$			30	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=250\mu\text{A}$	1.1	1.5	2.3	V
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$R_{\text{DS(ON)}}^{(5)}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{DS}}=3\text{A}$		90	115	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{DS}}=2\text{A}$		100	130	$\text{m}\Omega$
<b>Diode Characteristics</b>						
$V_{\text{SD}}^{(5)}$	Diode Forward Voltage	$I_{\text{SD}}=3\text{A}, V_{\text{GS}}=0\text{V}$		0.82	1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_{\text{SD}}=3\text{A}, dI_{\text{SD}}/dt=100\text{A}/\mu\text{s}$		12		ns
$Q_{\text{rr}}$	Reverse Recovery Charge			23		nC
<b>Dynamic Characteristics</b> <sup>(6)</sup>						
$R_{\text{G}}$	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, F=1\text{MHz}$		2.1		$\Omega$
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=50\text{V}, \text{Frequency}=1.0\text{MHz}$		815		$\text{pF}$
$C_{\text{oss}}$	Output Capacitance			40		
$C_{\text{rss}}$	Reverse Transfer Capacitance			25		
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{DD}}=50\text{V}, I_{\text{DS}}=3\text{A}, V_{\text{GEN}}=10\text{V}, R_{\text{G}}=3\Omega$		7		ns
$t_{\text{r}}$	Turn-on Rise Time			10		
$t_{\text{d(OFF)}}$	Turn-off Delay Time			16		
$t_{\text{f}}$	Turn-off Fall Time			9		
<b>Gate Charge Characteristics</b> <sup>(6)</sup>						
$Q_{\text{g}}$	Total Gate Charge	$V_{\text{DS}}=50\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{DS}}=3\text{A}$		20		nC
$Q_{\text{gs}}$	Gate-Source Charge			1.8		
$Q_{\text{gd}}$	Gate-Drain Charge			4.7		

Notes:

- ①Pulse width limited by safe operating area.
- ②Calculated continuous current based on maximum allowable junction temperature.
- ③When mounted on 1 inch square copper board,  $t \leq 10\text{sec}$ . The value in any given application depends on the user's specific board design.
- ④Limited by  $T_{J\text{max}}$ , Starting  $T_J = 25^\circ\text{C}$ ,  $I_{AS\text{max}} = 10\text{A}$ ,  $L = 0.5\text{mH}$ ,  $V_{\text{DD}} = 48\text{V}$ ,  $R_G = 25\Omega$ ,  $V_{\text{GS}} = 10\text{V}$ . Part not recommended for use above this value.
- ⑤Pulse test; Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- ⑥Guaranteed by design, not subject to production testing.

**Ordering and Marking Information**

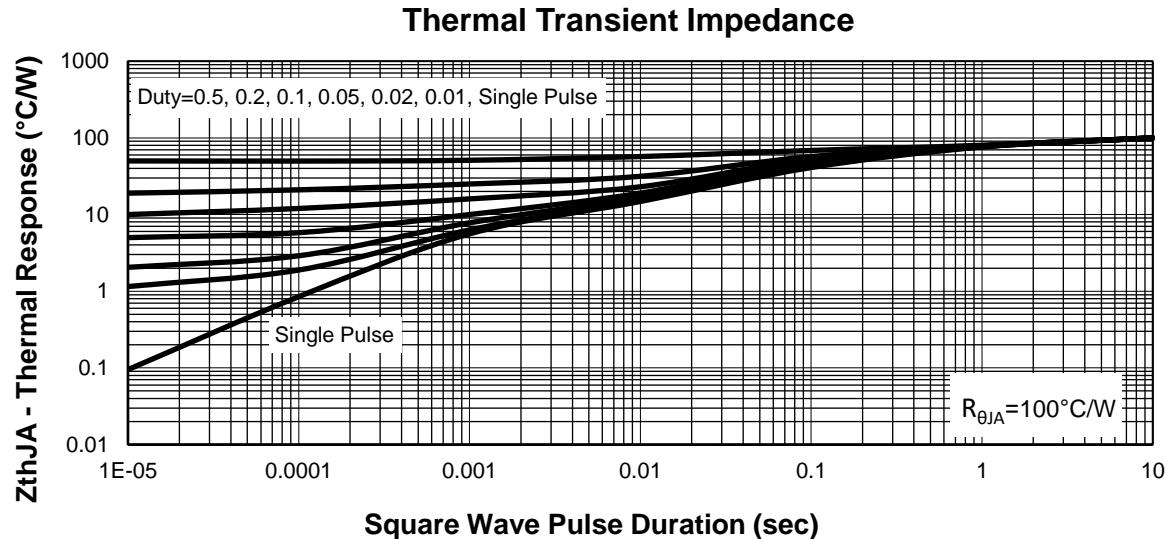
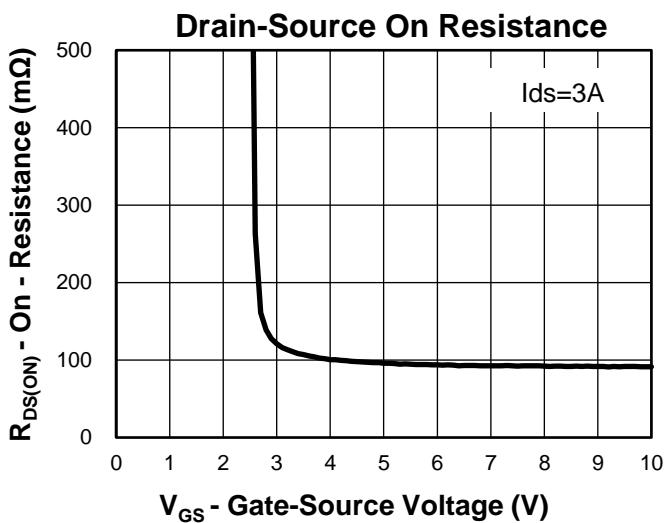
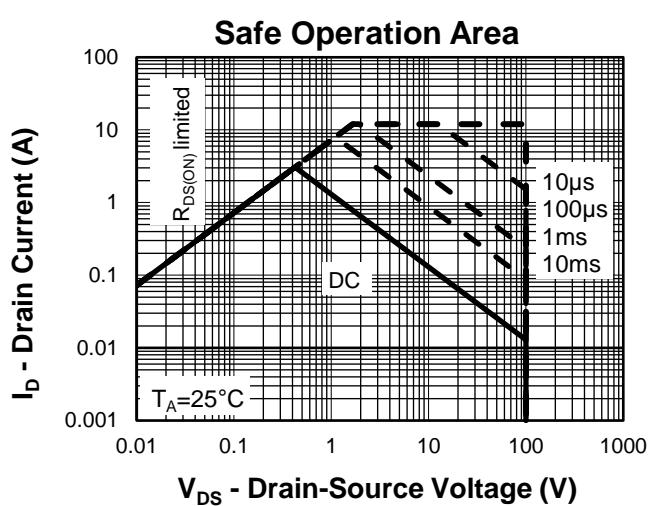
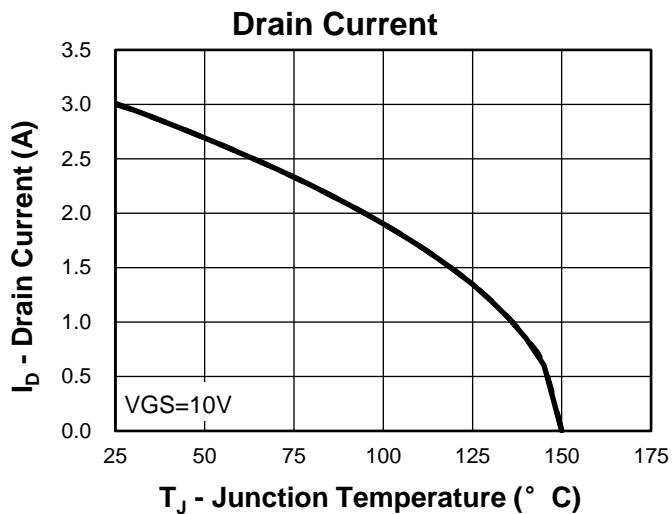
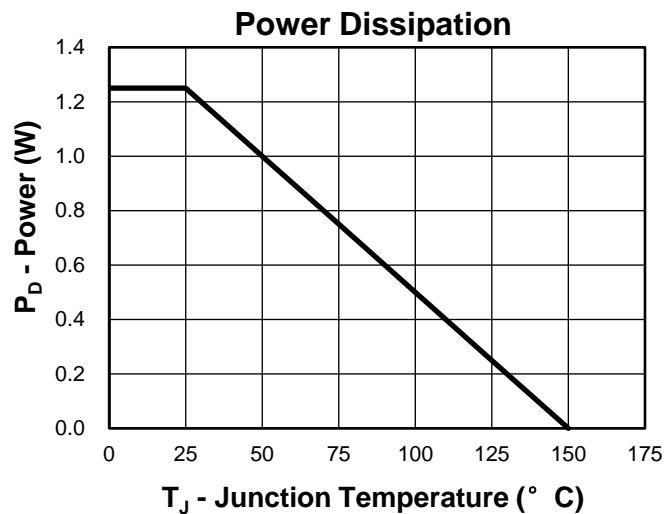
Device	Package	Packaging	Quantity	Reel Size	Tape width
KS1224EA	SOT23-3L	Tape&Reel	3000	7"	8mm



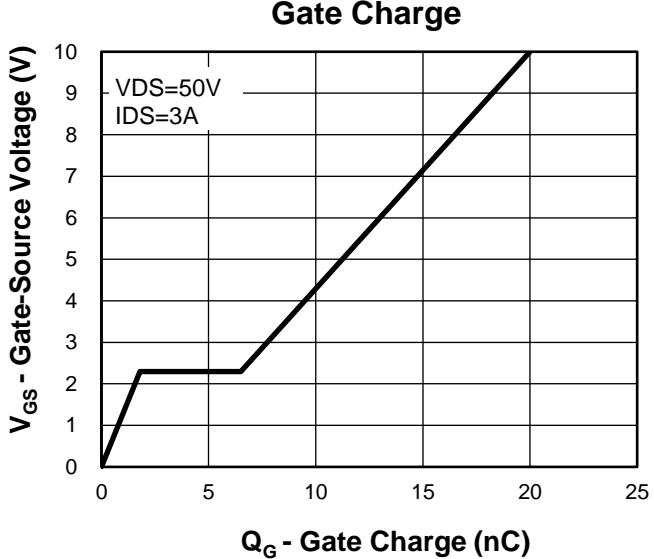
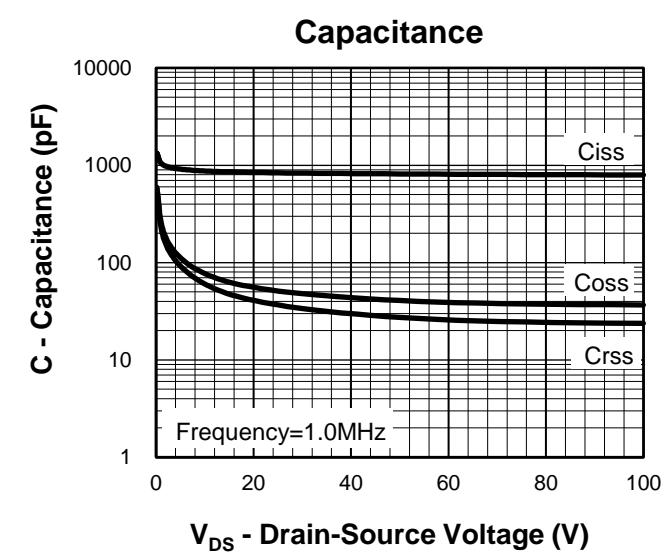
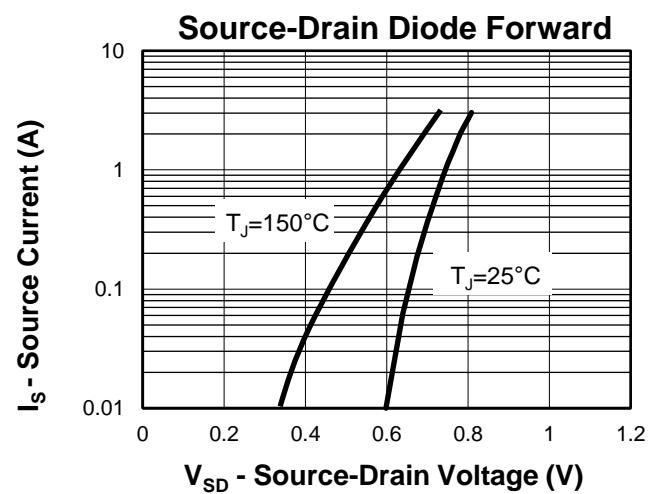
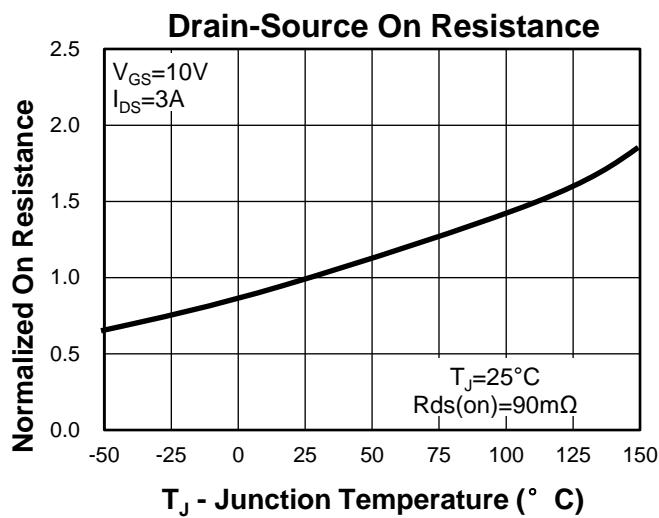
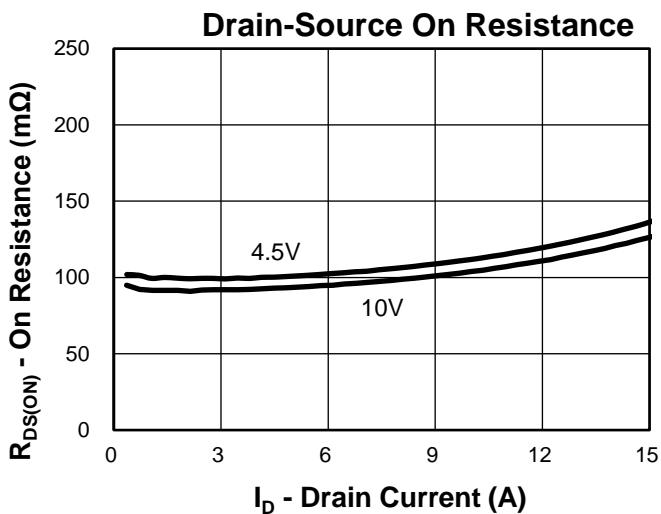
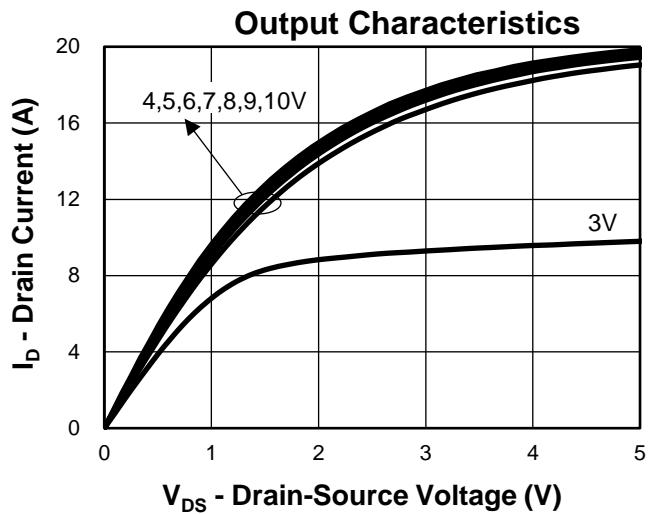
Y =Year,2017-A,2018-B,etc.

M =Month,Jan-1,Feb-2,...,Sep-9,Oct-A,Nov-B,Dec-C.

## Typical Characteristics

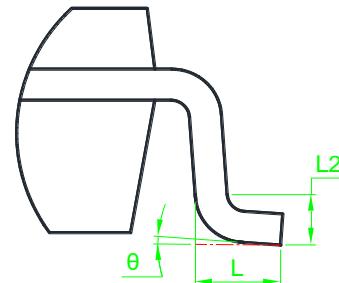
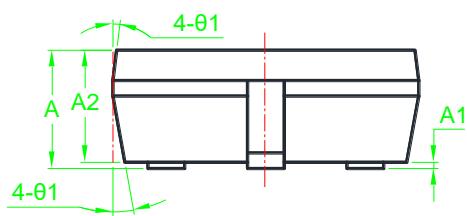
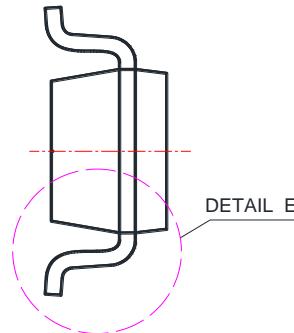
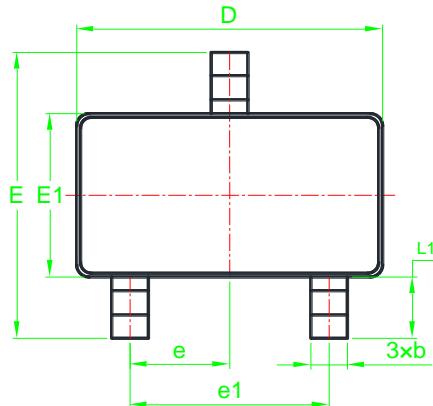


## Typical Characteristics



## Package Information

### SOT23-3L

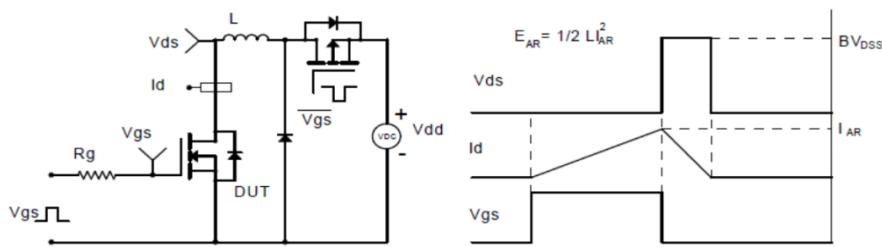


DETAIL E

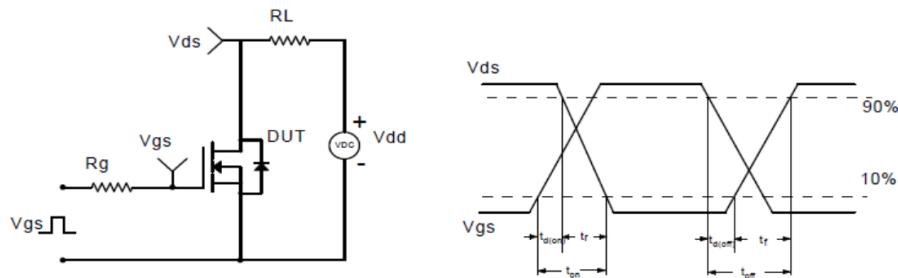
SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX	e	0.95BSC		0.037BSC			
A	1.05	1.15	1.25	0.041	0.045	0.049	e	0.95BSC		0.037BSC			
A1	0.01	*	0.10	0.000	*	0.004	e1	1.9BSC		0.075BSC			
A2	1.05	1.10	1.15	0.041	0.043	0.045	L	0.30	0.45	0.60	0.012	0.018	0.024
b	0.30	0.40	0.50	0.012	0.016	0.020	L1	0.6REF		0.024REF			
D	2.82	2.92	3.02	0.111	0.115	0.119	L2	0.254BSC		0.01BSC			
E	2.65	2.80	2.95	0.104	0.110	0.116	$\theta$	0°	*	8°	0°	*	8°
E1	1.50	1.60	1.70	0.059	0.063	0.067	$\theta_1$	0°	*	10°	0°	*	10°

Note: Dimensions do not include burrs and mold flash.

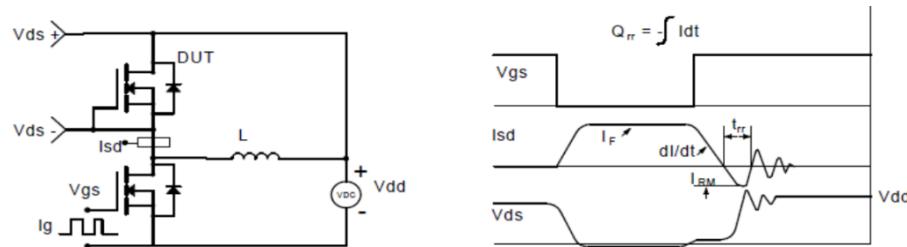
### Avalanche Test Circuit and Waveforms



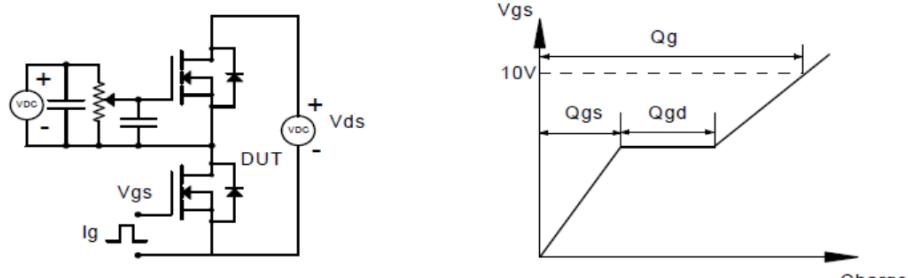
### Switching Time Test Circuit and Waveforms



### Diode Recovery Test Circuit and Waveforms



### Gate Charge Test Circuit and Waveform



### Customer Service

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Web:[www.kwansemi.com](http://www.kwansemi.com)

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